

# DECLARATION Original United States Patent Application

As a below named inventor I hereby declare that:

My residence, post office address and citizenship are as stated below n xt to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## MOBILE PHONE WITH SIM CARD HOLDER

IDENTIFICATION OF S	PECIFICATION:				
The specification of which is attached hereto unless the following item is checked:					
was filed on as United States Application Serial Number and was amended on (if applicable).					
ACKNOWLEDGEMENT OF REVIEW OF PAPERS AND DUTY OF CANDOR:					
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.					
I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56, including, for continuation-in-part applications, material information which became available between the filing date of the prior application and the continuation-in-part application.					
FOREIGN PRIORITY CI	LAIM:				
application(s) for patent	or inventor's certificate li patent or inventor's cert	e 35, United States Code, §1 sted below and have also ide ificate having a filing date be	entified below any		
APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)	Certified Copy Attached		
91221335	Taiwan, R.O.C	27-Dec-2002			
-		n a supplementary priority da			
APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)			
		1			

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on a supplementary foreign application sheet attached hereto.

#### DOMESTIC PRIORITY CLAIM

I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional applications listed below.

APPLICATION NUMBER	DATE OF FILING (day, month, year)

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States Application in the matter provided by the first paragraph of Title 35, United States Code, §112, I acknowledge a duty to disclose material information as defined in Title 37, Coded of Federal Registrations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

APPLICATION	DATE OF FILING	STATUS
NUMBER	(day, month, year)	(patented, pending, abandoned)

#### **DECLARATION:**

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

### SIGNATURE(S):

Full Name Of Inventor 1	Family Name LIN	First Given Name Yi Yen	Second Given Name
Residence & Citizenship	City Taipei	State or Foreign Country Taiwan, R.O.C.	Country of Citizenship Taiwan, R.O.C.
Mailing Address	Address 2FI., No. 66-1, Lane 73, Dungyuan St., Wanhua Chiu, Taipei, Taiwan 108, R.O.C.	City Taipei	State & Zip Code/Country Taiwan, R.O.C.
Signature of I	nventor 1: Lin Y;	Yen	Date: Dec/o2/'03

Additional inventors are listed on a supplementary inventor sheet attached hereto.

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BENQ Corporation, a Corporation, located at 157, Shan-Ying Rd., Kewishan,
Taoyuan 333, Taiwan, R.O.C., as assignee of record of the entire interest of the of the
subject matter which is claimed in the patent application entitled:  MOBILE PHONE WITH SIM CARD HOLDER
, which was filed on as United States Application Serial Number, or for which the specification of which is attached hereto.
Number, or for which the specification of which is attached hereto.
POWER OF ATTORNEY:
The following attorney(s) and/or patent agent(s) are hereby appointed to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:
Nelson A. Quintero, #52,143, of the firm Quintero Law Office
The undersigned to this power of attorney hereby authorizes the attorneys named above to act and rely on instructions from and communicate directly with the person/attorney/firm/organization who/which first sends/sent this case. In the event of a change in the person(s) from whom instructions may be taken, the attorneys will be so notified by the undersigned.
Please direct all correspondence to: Please direct telephone calls to:
Nelson A. Quintero, Esq. Nelson A. Quintero
Quintero Law Office 1-310-401-6180 1617 Broadway, 3 <sup>rd</sup> Floor
Santa Monica, California 90404
ASSIGNEE STATEMENT UNDER 37 C.F.R. § 3.73(b):
Assignee certifies that it is the assignee of the patent application identified above by virtue of an assignment from the inventor(s) of said patent application. The assignment was recorded in the Patent and Trademark Office at Reel, Frame, or for which a copy thereof s attached hereto.
The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the assignee.
hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.
Der 9, 200) Signature  Signature
Date Signature Signature
Shen Woon Chen
Typed or printed name
Vice President
Title